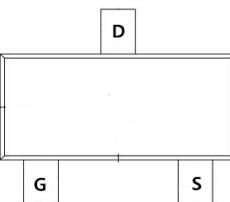
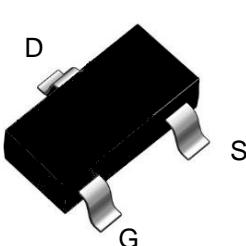
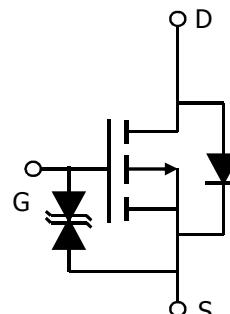


<b>General Description</b> <ul style="list-style-type: none"> <li>• Low <math>R_{DS(ON)}</math></li> <li>• RoHS and Halogen-Free Compliant</li> </ul> <b>Applications</b> <ul style="list-style-type: none"> <li>• Load switch</li> <li>• PWM</li> </ul>	<b>General Features</b> <p> <math>V_{DS} = -20V</math> <math>I_D = -6.0A</math>  <math>R_{DS(ON)} = 27\text{ m}\Omega</math> (typ.) @ <math>V_{GS} = -10V</math>          ESD Protection          100% UIS Tested          100% <math>R_g</math> Tested       </p> <div style="text-align: right; margin-top: 10px;">  </div>
<b>I:SOT-23</b> <div style="display: flex; justify-content: space-around; align-items: center;"> <div style="text-align: center;">  <p>Marking: 3415A</p> </div> <div style="text-align: center;">  </div> <div style="text-align: center;">  </div> </div>	

**Absolute Maximum Ratings ( $T_A = 25^\circ C$  Unless Otherwise Noted)**

Symbol	Parameter	Rating	Units
$V_{DS}$	Drain-Source Voltage	-20	V
$V_{GS}$	Gate-Source Voltage	$\pm 12$	V
$I_D @ T_A = 25^\circ C$	Continuous Drain Current, $V_{GS} @ -4.5V^1$	-6.0	A
$I_D @ T_A = 70^\circ C$	Continuous Drain Current, $V_{GS} @ -4.5V^1$	-4.2	A
$I_{DM}$	Pulsed Drain Current <sup>2</sup>	-21	A
$P_D @ T_A = 25^\circ C$	Total Power Dissipation <sup>3</sup>	1.34	W
$P_D @ T_A = 70^\circ C$	Total Power Dissipation <sup>3</sup>	0.84	W
$T_{STG}$	Storage Temperature Range	-55 to 150	°C
$T_J$	Operating Junction Temperature Range	-55 to 150	°C

**Thermal Data**

Symbol	Parameter	Typ.	Max.	Unit
$R_{\theta JA}$	Thermal Resistance Junction-Ambient <sup>1</sup>	---	125	°C/W
$R_{\theta JA}$	Thermal Resistance Junction-Ambient <sup>1</sup> ( $t \leq 10s$ )	---	---	°C/W

**Electrical Characteristics** ( $T_J=25^\circ\text{C}$  unless otherwise specified)

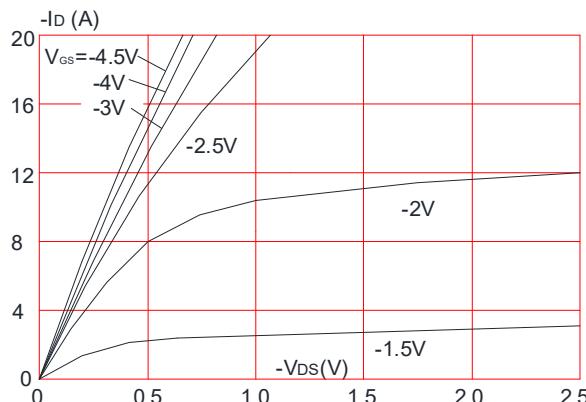
Symbol	Parameter	Test Condition	Min.	Typ.	Max.	Units
<b>Off Characteristic</b>						
$V_{(BR)DSS}$	Drain-Source Breakdown Voltage	$V_{GS}=0\text{V}$ , $I_D= -250\mu\text{A}$	-20	-	-	V
$I_{DSS}$	Zero Gate Voltage Drain Current	$V_{DS}= -20\text{V}$ , $V_{GS}=0\text{V}$ ,	-	-	-1	$\mu\text{A}$
$I_{GSS}$	Gate to Body Leakage Current	$V_{DS}=0\text{V}$ , $V_{GS}= \pm 12\text{V}$	-	-	$\pm 100$	nA
<b>On Characteristics</b>						
$V_{GS(\text{th})}$	Gate Threshold Voltage	$V_{DS}=V_{GS}$ , $I_D= -250\mu\text{A}$	-0.4	-0.7	-1.0	V
$R_{DS(\text{on})}$ note2	Static Drain-Source on-Resistance	$V_{GS}= -4.5\text{V}$ , $I_D= -4.1\text{A}$	-	26	35	$\text{m}\Omega$
		$V_{GS}= -2.5\text{V}$ , $I_D= -3\text{A}$	-	36	43	
<b>Dynamic Characteristics</b>						
$C_{iss}$	Input Capacitance	$V_{DS}= -10\text{V}$ , $V_{GS}=0\text{V}$ , $f=1.0\text{MHz}$	-	430	-	pF
$C_{oss}$	Output Capacitance		-	132	-	pF
$C_{rss}$	Reverse Transfer Capacitance		-	85	-	pF
$Q_g$	Total Gate Charge	$V_{DS}= -10\text{V}$ , $I_D= -2\text{A}$ , $V_{GS}= -4.5\text{V}$	-	8.8	-	nC
$Q_{gs}$	Gate-Source Charge		-	1.4	-	nC
$Q_{gd}$	Gate-Drain("Miller") Charge		-	1.9	-	nC
<b>Switching Characteristics</b>						
$t_{d(on)}$	Turn-on Delay Time	$V_{DD}= -10\text{V}$ , $I_D= -3.3\text{A}$ , $R_G= 1\Omega$ , $V_{GEN}= -4.5\text{V}$	-	10	-	ns
$t_r$	Turn-on Rise Time		-	32	-	ns
$t_{d(off)}$	Turn-off Delay Time		-	50	-	ns
$t_f$	Turn-off Fall Time		-	51	-	ns
<b>Drain-Source Diode Characteristics and Maximum Ratings</b>						
$I_s$	Maximum Continuous Drain to Source Diode Forward Current	-	-	-6.0	-	A
$I_{SM}$	Maximum Pulsed Drain to Source Diode Forward Current	-	-	-16	-	A
$V_{SD}$	Drain to Source Diode Forward Voltage	$V_{GS}=0\text{V}$ , $I_s= -4.1\text{A}$	-	-	-1.2	V

Notes:1. Repetitive Rating: Pulse Width Limited by Maximum Junction Temperature

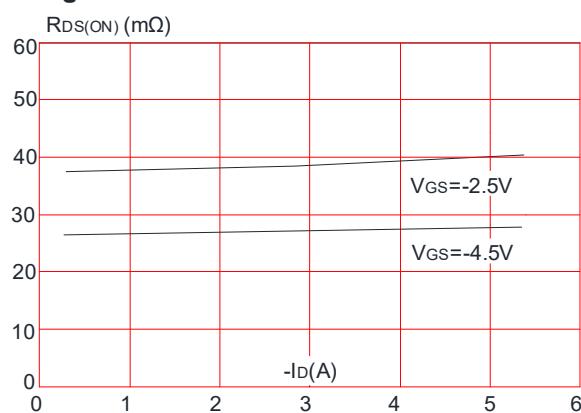
2. Pulse Test: Pulse Width $\leq 300\mu\text{s}$ , Duty Cycle $\leq 2\%$

## Typical Performance Characteristics

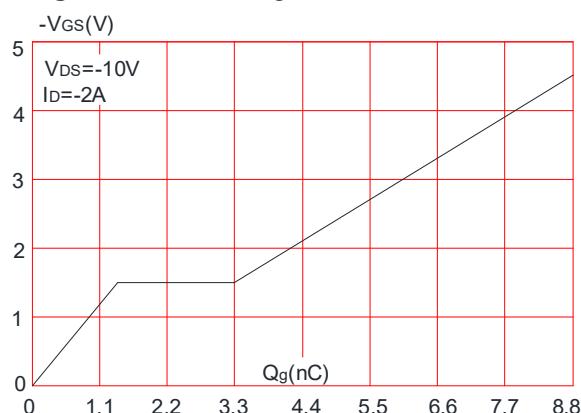
**Figure 1:** Output Characteristics



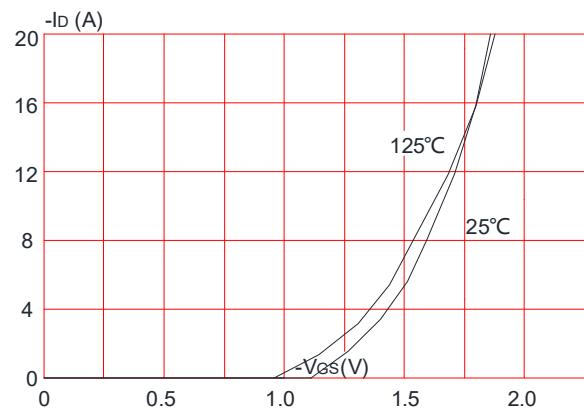
**Figure 3:** On-resistance vs. Drain Current



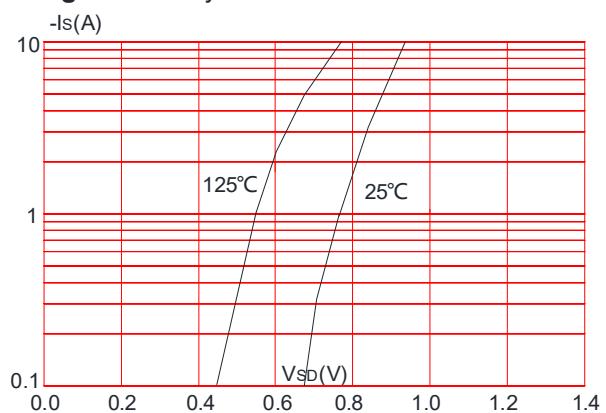
**Figure 5: Gate Charge Characteristics**



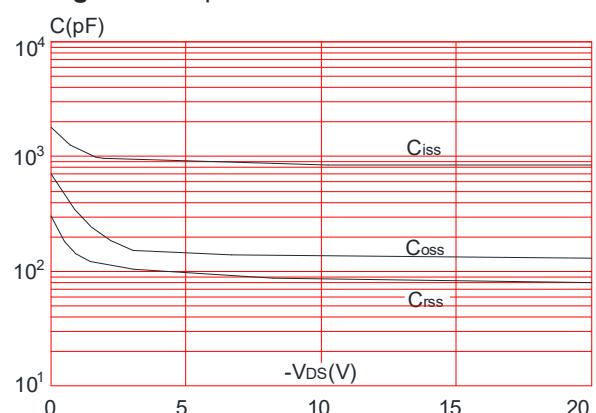
**Figure 2:** Typical Transfer Characteristics



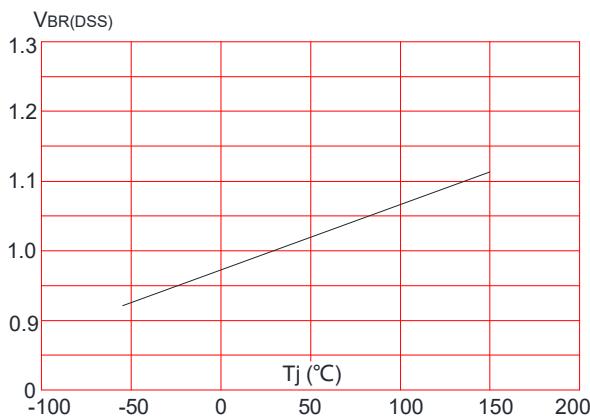
**Figure 4:** Body Diode Characteristics



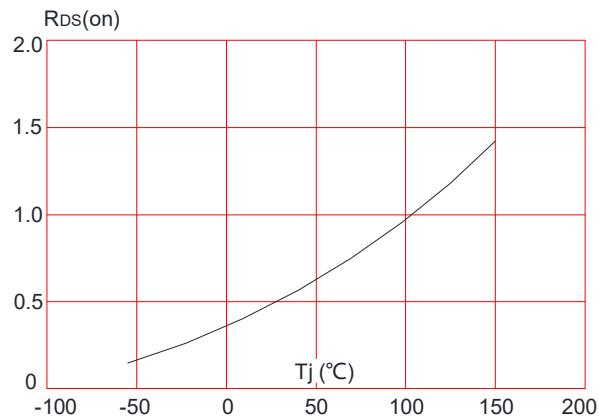
**Figure 6: Capacitance Characteristics**



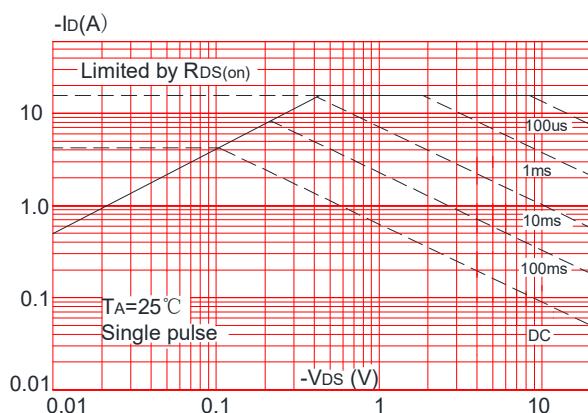
**Figure 7:** Normalized Breakdown Voltage vs. Junction Temperature



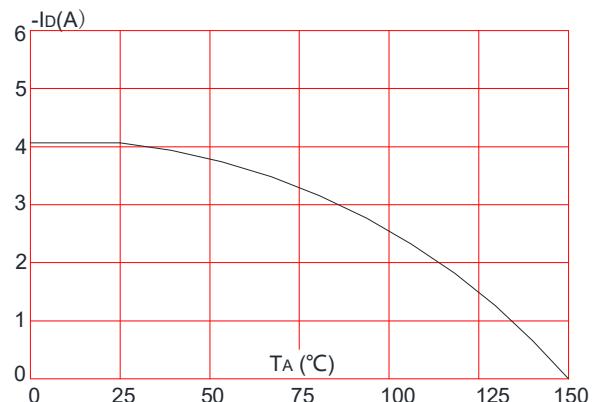
**Figure 8:** Normalized on Resistance vs. Junction Temperature



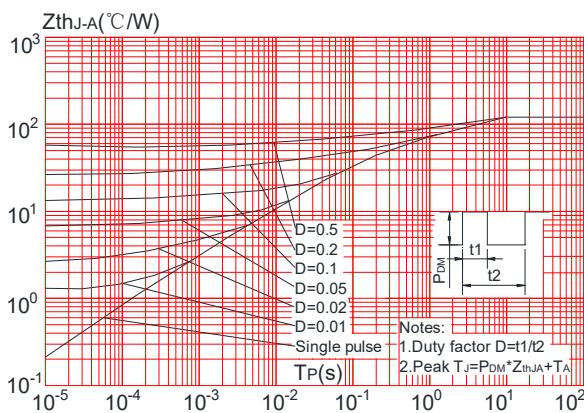
**Figure 9:** Maximum Safe Operating Area



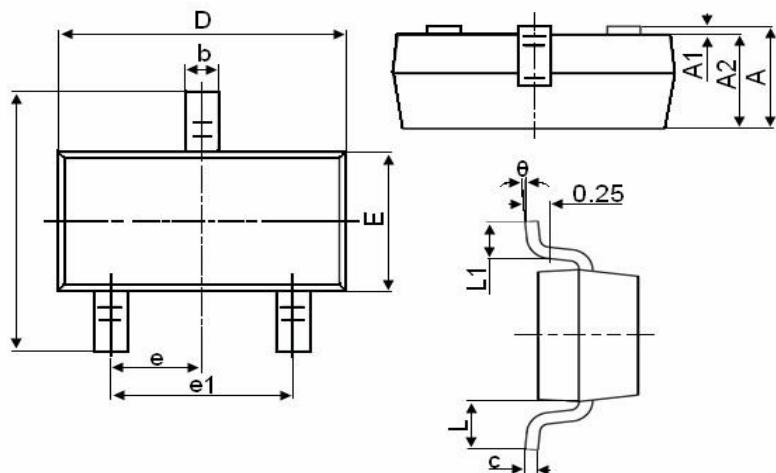
**Figure 10:** Maximum Continuous Drain Current vs. Ambient Temperature



**Figure 11:** Maximum Effective Transient Thermal Impedance, Junction-to-Ambient



## Package Mechanical Data:SOT-23



Symbol	Dimensions in Millimeters	
	MIN.	MAX.
A	0.900	1.150
A1	0.000	0.100
A2	0.900	1.050
b	0.300	0.500
c	0.080	0.150
D	2.800	3.000
E	1.200	1.400
E1	2.250	2.550
e	0.950TYP	
e1	1.800	2.000
L	0.550REF	
L1	0.300	0.500
θ	0°	8°